

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT3148204

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
HYUN SUB KIM	11/21/2014
BOCK CHEOL LEE	11/21/2014
NAK KYOUNG KONG	11/21/2014
YOUNG SUB OH	11/21/2014
JIN HEE LEE	11/21/2014
JIN WAN PARK	11/21/2014
JI YONG JEONG	11/21/2014
JE SEONG LEE	11/21/2014
JAE HYUCK AN	11/21/2014
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	HYUNDAI MOTOR COMPANY
<b>Street Address:</b>	12, HEOLLEUNG-RO, SEOCHO-GU
<b>City:</b>	SEOUL
<b>State/Country:</b>	KOREA, REPUBLIC OF
<b>Postal Code:</b>	137-938
<b>Name:</b>	KCW CORPORATION
<b>Street Address:</b>	262, SEONGSEOGONGDANBUK-RO, DALSEO-GU
<b>City:</b>	DAEGU
<b>State/Country:</b>	KOREA, REPUBLIC OF
<b>Postal Code:</b>	702-901
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	14570942
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(415)442-1001
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	4154421724
<b>Email:</b>	jvalles@morganlewis.com
<b>Correspondent Name:</b>	JERE VALLES.MORGAN, LEWIS & BOCKIUS LLP
<b>PATENT</b>	

<b>Address Line 1:</b>	ONE MARKET, SPEAR STREET TOWER, SUITE 28
<b>Address Line 4:</b>	SAN FRANCISCO, CALIFORNIA 94105

<b>ATTORNEY DOCKET NUMBER:</b>	060943-5312-US
--------------------------------	----------------

<b>NAME OF SUBMITTER:</b>	JERE VALLES
---------------------------	-------------

<b>SIGNATURE:</b>	/jere valles/
-------------------	---------------

<b>DATE SIGNED:</b>	12/15/2014
---------------------	------------

**Total Attachments: 4**

source=060943\_5312\_US\_ASS#page1.tif

source=060943\_5312\_US\_ASS#page2.tif

source=060943\_5312\_US\_ASS#page3.tif

source=060943\_5312\_US\_ASS#page4.tif

**ASSIGNMENT**  
(Joint Inventors)

WHEREAS, the undersigned, (1) **KIM, Hyun Sub**, resident of **203, Sin E-morning Vill Apt., 30, Eunhaengjeong-ro, Yangcheon-gu, Seoul, 158-860, Republic of Korea** and (2) **LEE, Bock Cheol**, resident of **122-1603, Cheoncheon Purgio Apt., 85, Hwasan-ro, Jangan-gu, Suwon-si, Gyeonggi-do, 440-410, Republic of Korea**, and (3) **KONG, Nak Kyoung**, resident of **201, 8-3, Pangyo-ro 25beon-gil, Bundang-gu, Seongnam-si, Gyeonggi-do, 463-440, Republic of Korea**, and (4) **OH, Young Sub**, resident of **612-2101, Cheongsol Jugong Apt., 33, Cheoncheon-ro 21beon-gil, Jangan-gu, Suwon-si, Gyeonggi-do, 440-733, Republic of Korea**, and (5) **LEE, Jin Hee**, resident of **701-1004, Hyundai HomeTown 7 Cha Apt., 41, Neungdong-ro 4-gil, Gwangjin-gu, Seoul, 143-775, Republic of Korea**, and (6) **PARK, Jin Wan**, resident of **101-1308, Hyundai Mansion, 115, Bokhyeon-ro, Buk-gu, Daegu, 702-827, Republic of Korea**, and (7) **JEONG, Ji Yong**, resident of **103-1009, Jerim Apt., 196, Sanghwabuk-ro, Dalseo-gu, Daegu, 704-762, Republic of Korea**, and (8) **LEE, Je Seong**, resident of **70-11, Myeongnyun-ro 22-gil, Jung-gu, Daegu, 700-826, Republic of Korea**, and (9) **AN, Jae Hyuck**, resident of **61-7, Pagye-ro 120-gil, Dong-gu, Daegu, 701-490, Republic of Korea** (hereinafter termed "Inventors"), respectively, have invented certain new and useful improvements in **WASHER NOZZLE INTEGRATED WIPER BLADE** and executed therefore an application for Letters Patent of the United States and

☒ having an oath or declaration executed on even date herewith.  
☐ bearing U.S. Patent Application No. \_\_\_\_\_ and filed on \_\_\_\_\_

WHEREAS, **Hyundai Motor Company** and **KCW Corporation, 12, Heolleung-ro, Seocho-gu, Seoul, 137-938, REPUBLIC OF KOREA** and **262, Seongseogongdanbuk-ro, Dalseo-gu, Daegu, 702-901, REPUBLIC OF KOREA, ASSIGNEE** are desirous of obtaining our entire right, title and interest in, to and under the said invention and the said application and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered jointly or severally by said Inventors (all collectively hereinafter termed "said invention"), and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter termed "patents") thereon granted in the United States and foreign countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Inventors to have been received in full from said Assignee:

1. Said Inventors do hereby sell, assign, transfer and convey unto said Assignee, the entire right, title and interest (a) in and to said application and said invention; (b) in and to all rights to apply for

foreign patents on said invention pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all applications filed and any and all patents granted on said invention in the United States or any foreign country, including each and every application filed and each and every patent granted on any application which is a division, substitution, or continuation of any of said applications; and (d) in and to each and every reissue or extensions of any of said patents.

2. Said Inventors do hereby jointly and severally covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right title and interest herein conveyed in the United States and foreign countries. Such cooperation by said Inventors shall include prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (d) for filing and prosecuting applications for reissuance of any said patents; (e) for interference or other priority proceedings involving said invention; and (f) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventors in providing such cooperation shall be paid for by said Assignee.

3. The terms and covenants of this assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventors, their respective heirs, legal representatives and assigns.

4. Said Inventors do hereby jointly and severally warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Inventors have executed and delivered this instrument to said Assignee as follows:

November 21, 2014

Date: 21-11-2014

(1) KIM, Hyun Sub

By: Kim Hyun Sub

November 21, 2014

Date: 21-11-2014

(2) LEE, Bock Cheol

By: Lee Bock Cheol

November 21, 2014

Date: 21-11-2014

(3) KONG, Nak Kyoung

By: Kong, Nak Kyoung

November 21, 2014

Date: 21-11-2014

(4) OH, Young Sub

By: Oh young sub

November 21, 2014

Date: 21-11-2014

(5) LEE, Jin Hee

By: Lee, Jin Hee

November 21, 2014

Date: 24-11-2014

(6) PARK, Jin Wan

By: Park Jin Wan

November 21, 2014

Date: 24-11-2014

(7) JEONG, Ji Yong

By: Jeong, Ji Yong

PATENT

Attorney Docket No.060943-5312-US

Date: November 21, 2014

24 - 11 - 2014

(8) LEE, Je Seong

By:

Lee Je Seong

Date: November 21, 2014

24 - 11 - 2014

(9) AN, Jae Hyuck

By:

An Jae Hyuck